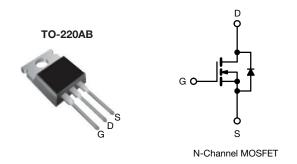
SiHP21N60EF



Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.176		
Q _g (Max.) (nC)	84			
Q _{gs} (nC)	14			
Q _{gd} (nC)	24			
Configuration	Single			

FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM): Ron x Qg
- Low input capacitance (Ciss)
- Increased robustness due to low Q_{rr}
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High intensity discharge (HID)
 - Light emitting diodes (LEDs)
- Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
 - Battery chargers
- Renewable energy
- Solar (PV inverters)
- Switch mode power suppliers (SMPS)
- Applications using the following topologies
 - LLC
 - Phase shifted bridge (ZVS)
 - 3-level inverter
 - AC/DC bridge

ORDERING INFORMATION

Package TO-220AB			
Lead (Ph) free and helegen free	SiHP21N60EF-BE3 ^a		
Lead (Pb)-free and halogen-free	SiHP21N60EF-GE3		

Note

a. "-BE3" denotes alternate manufacturing location

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	600	V
Gate-source voltage			V _{GS}	± 30	
Continuous drain current (T_J = 150 °C)	V _{GS} at 10 V T _C	= 25 °C = 100 °C	- I _D -	21	A
	V _{GS} at 10 V T _C	= 100 °C		14	
Pulsed drain current ^a			I _{DM}	53	1
Linear derating factor				1.8	W/°C
Single pulse avalanche energy b			E _{AS}	367	mJ
Maximum power dissipation			PD	227	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	T _J = 125 °C	0		70	V/ns
Reverse diode dV/dt ^d			dV/dt	50	v/ns
Soldering recommendations (peak temperature) ^c	For 10 s			300	°C

a. Repetitive rating; pulse width limited by maximum junction temperature

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_g = 25 \Omega$, $I_{AS} = 5.1$ A

- c. 1.6 mm from case
- d. $I_{SD} \leq I_D$, dI/dt = 900 A/µs, starting T_J = 25 °C

S22-0948-Rev. D, 21-Nov-2022



COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	0.55		

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static					•	•	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	-	0.59	-	V/°C	
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$			4.0	V
Gate-source leakage	I _{GSS}	$V_{GS} = \pm 20 V$		-	-	± 100	nA
			$V_{\rm GS}$ = ± 30 V	-	-	± 1	μA
Zava gata valtaga drain avvent	1	V _{DS} =	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	500	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 11 A	-	0.153	0.176	Ω
Forward transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 11 A		-	7	-	S
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2030	-	pF
Output capacitance	C _{oss}			-	105	-	
Reverse transfer capacitance	C _{rss}			-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V_{GS} = 0 V, V_{DS} = 0 V to 480 V		-	86	-	
Effective output capacitance, time related ^b	C _{o(tr)}			-	299	-	
Total gate charge	Q _q			-	56	84	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 11 A, V _{DS} = 480 V		14	-	nC
Gate-drain charge	Q _{gd}			-	24	-	1
Turn-on delay time	t _{d(on)}			-	21	42	
Rise time	t _r	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 11 \text{ A}$ $\text{R}_{g} = 9.1 \Omega, \text{ V}_{\text{GS}} = 10 \text{ V}$		-	31	62	- ns
Turn-off delay time	t _{d(off)}			-	59	89	
Fall time	t _f				27	54	
Gate input resistance	R _g	f = 1 MHz, open drain		0.2	0.56	1.2	Ω
Drain-Source Body Diode Characteristic	cs				•	•	•
Continuous source-drain diode current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21	- A
Pulsed diode forward current	I _{SM}			-	-	53	
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	0.9	1.2	V
Reverse recovery time	t _{rr}	$T_J = 25 ^{\circ}C, I_F = I_S = 11 A,$ dl/dt = 100 A/µs, V _B = 400 V		-	135	270	ns
Reverse recovery charge	Q _{rr}			-	0.76	1.52	μC
Reverse recovery current	I _{RRM}		$v_{\rm R} = 400 v$	-	11	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

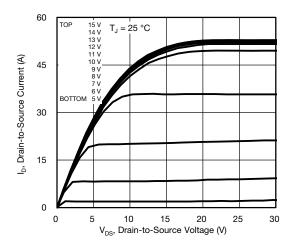


Fig. 1 - Typical Output Characteristics, T_J = 25 °C

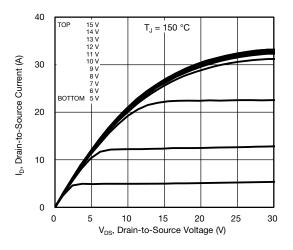


Fig. 2 - Typical Output Characteristics, T_J = 150 °C

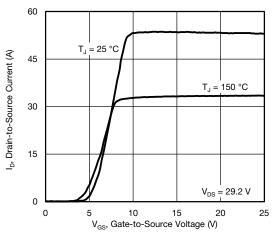


Fig. 3 - Typical Transfer Characteristics

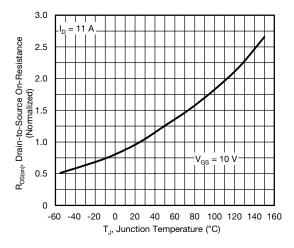


Fig. 4 - Normalized On-Resistance vs. Temperature

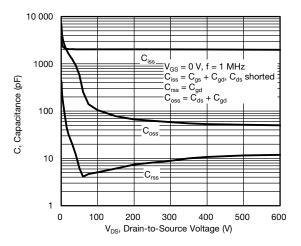
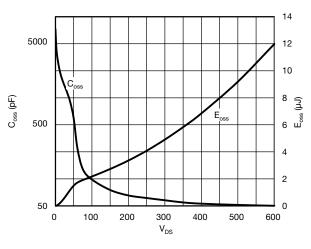
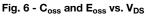


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





3

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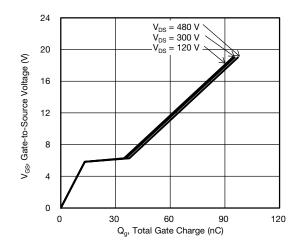


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

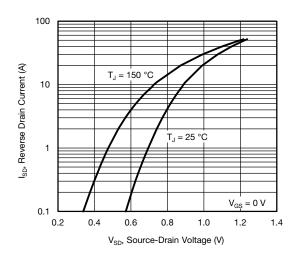


Fig. 8 - Typical Source-Drain Diode Forward Voltage

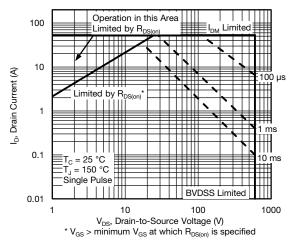


Fig. 9 - Maximum Safe Operating Area

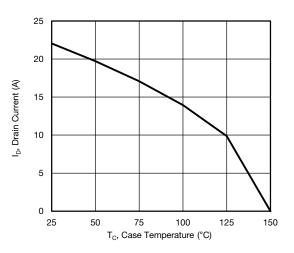


Fig. 10 - Maximum Drain Current vs. Case Temperature

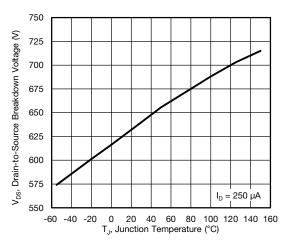


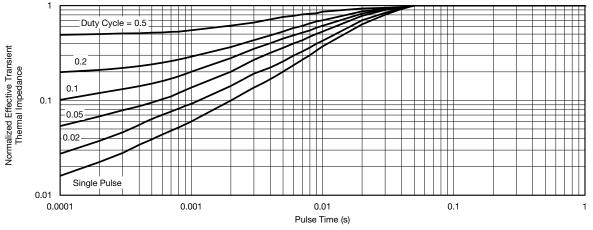
Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

4



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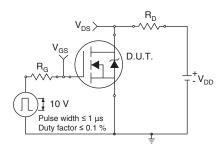


Fig. 13 - Switching Time Test Circuit

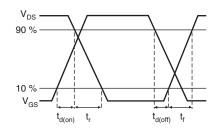


Fig. 14 - Switching Time Waveforms

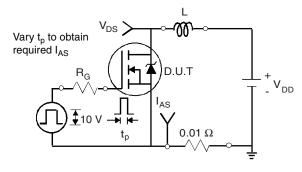
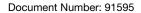


Fig. 15 - Unclamped Inductive Test Circuit

S22-0948-Rev. D, 21-Nov-2022

5



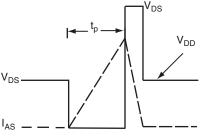


Fig. 16 - Unclamped Inductive Waveforms

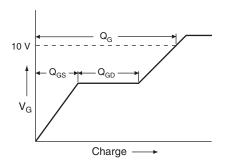
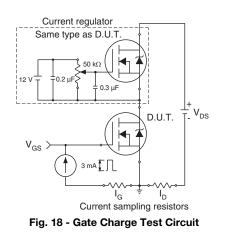


Fig. 17 - Basic Gate Charge Waveform





Peak Diode Recovery dV/dt Test Circuit

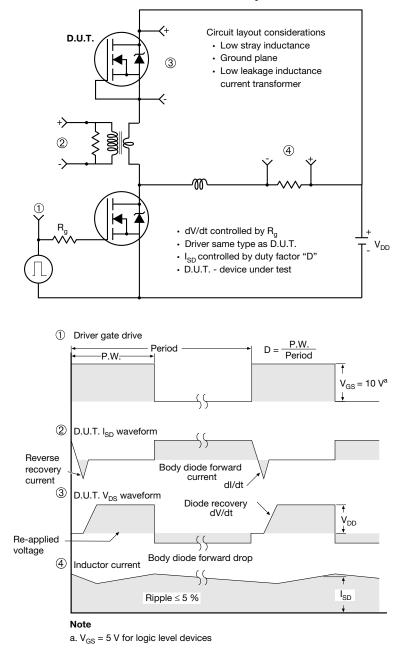


Fig. 19 - For N-Channel

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6

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